



2823

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re PATENT APPLICATION Of:

Group Art Unit: 2823  
Examiner: Suk San Foong

#11 / DDS  
5-21-03  
return

Applicant(s) : Yasuo TANAKA	)
Serial No. : 09/660,484	)
Filed : September 12, 2000	)
For: METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE	)
Attorney Ref. : OKI 262	)

**INFORMATION  
DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is an information disclosure statement submitted in compliance with the turning requirements of 37 C.F.R. §1.97(c), i.e., after a first Office Action on the merits but before Final Rejection and/or Notice of Allowance. Pursuant to 37 C.F.R. § 1.97(e)(2), it is certified that each item submitted with this Information Disclosure Statement was cited in an Office Action from the Japanese Patent Office in a counterpart foreign application on March 18, 2003, that is, less than three months prior to filing this Information Disclosure Statement.

Attached are copies of a Japanese Office Action and seven Japanese Patents with English translations, and one U.S. document therein. The U.S. patent is a translation of Japanese Application No. 10-79362. The relevance of the publications can be gleaned from the attached English language Abstracts. The documents are listed on the attached Form PTO-1449.

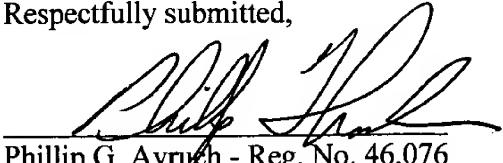
A check in payment of the \$180.00 fee under 37 C.F.R. §1.17(p) is also enclosed. If the check is missing, or made out for an insufficient amount, please charge our deposit account, No. 18-0002, for any deficiency and notify us accordingly.

FEE ENCLOSED: \$ 180.  
Please charge any further fees to our Deposit Account  
No. 18-0002

Consideration of the submitted documents is respectfully requested.

Respectfully submitted,

May 6, 2003  
Date

  
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## FORM PTO-1449

## INFORMATION DISCLOSURE STATEMENT

Atty. Docket

Application No.

OKI 262

09/660,484

Applicant

Yasuo TANAKA

Filing Date

September 12, 2000

Group

2823

## U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						

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## FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Sub-Class	Trans-lation
	AI	JP 10-79362	3/24/98	JAPAN			US Patent 2002/0030258A1 (attached)
	AJ						
	AK						
	AL						
	AM						
	AN						

## OTHER (Including Author, Title, Date, Pertinent Pages, etc.)

AO	
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Examiner

Date Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.



<b>FORM PTO-1449</b> <b>INFORMATION DISCLOSURE STATEMENT</b>		Atty. Docket	Application No.				
		OKI 262	09/660,484				
		Applicant Yasuo TANAKA					
Filing Date September 12, 2000	Group 2823						
<b>U.S. PATENT DOCUMENTS</b>							
Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date
	AA	2002/00302258A1	3/14/02	FUKASAWA et al			1/23/01
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
<b>FOREIGN PATENT DOCUMENTS</b>							
		Document Number	Date	Country	Class	Sub-Class	Trans-lation
	AI	JP 9-82850	3/28/97	JAPAN			Entire
	AJ	JP 11-343332	12/14/99	JAPAN			Claims/Abstract
	AK	JP 63-145323	6/17/88	JAPAN			Claims/Abstract
	AL	JP 2001-102499	4/13/01	JAPAN			Entire
	AM	JP 2001-144123	5/25/01	JAPAN			Entire
	AN	JP 2000-299333	10/24/00	JAPAN			Entire
<b>OTHER (Including Author, Title, Date, Pertinent Pages, etc.)</b>							
	AO						
Examiner _____							Date Considered _____
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.							